



40V +175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
40V	15mΩ @ V _{GS} = 10V	42A

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low Rds(ON) Minimizes On-State Losses
- Low Input Capacitance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH4011SPDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

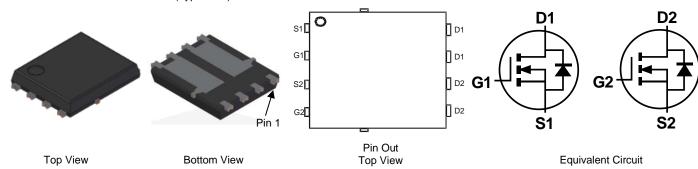
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Backlighting
- Power-management functions
- DC-DC converters

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202. Method 208 (23)
- Weight: 0.097 grams (Approximate)

PowerDI5060-8/SWP (Type UXD)



Ordering Information (Note 4)

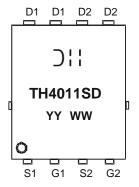
Part Number	Pookage	Packing		
Part Number	Package	Qty.	Carrier	
DMTH4011SPDWQ-13	PowerDI5060-8/SWP (Type UXD)	2,500	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



⊃¦¦ = Manufacturer's Marking TH4011SD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 23 = 2023)WW = Week (01 to 53)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	40	V	
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 5)	$T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$	lD	42 29.7	А
Continuous Drain Current (Note 6)	T _A = +25°C T _A = +100°C	lD	11.1 7.8	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	70	Α	
Maximum Continuous Body Diode Forward Current (Note 5)	ls	39.3	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle =	Ism	70	Α	
Avalanche Current, L = 0.3mH	I _{AS}	11.9	Α	
Avalanche Energy, L = 0.3mH	Eas	21.4	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.6	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	57	°C/W	
Total Power Dissipation (Note 5)	PD	37.5	W	
Thermal Resistance, Junction to Case (Note 5)	Rejc	4	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

Notes:

^{5.} Thermal resistance from junction to soldering point (on the exposed drain pad).6. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	40	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	-		1	μΑ	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	Igss	-	1	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	2		4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		11.6	15	mΩ	$V_{GS} = 10V, I_D = 20A$	
Diode Forward Voltage	V _{SD}	1	I	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)	DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		805	_	pF	V _{DS} = 20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	1	208		pF		
Reverse Transfer Capacitance	Crss	1	15		pF		
Gate Resistance	Rg		2.76	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg		10.6		nC	V _{DS} = 20V, I _D = 20A V _{GS} = 10V	
Gate-Source Charge	Qgs	1	2.2	1	nC		
Gate-Drain Charge	Qgd	-	2.7	-	nC		
Turn-On Delay Time	td(ON)	_	4.1	_	ns	$V_{DD} = 20V, V_{GS} = 10V$ $R_g = 1.6\Omega, I_D = 20A$	
Turn-On Rise Time	t _R		3.8	_	ns		
Turn-Off Delay Time	tD(OFF)		8.6		ns		
Turn-Off Fall Time	tF		1.9	_	ns		
Body Diode Reverse Recovery Time	trr	_	10.2	_	ns	I _F = 15A, dI/dt = 400A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	9.6	_	nC		

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





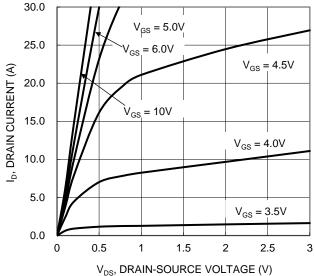


Figure 1. Typical Output Characteristic

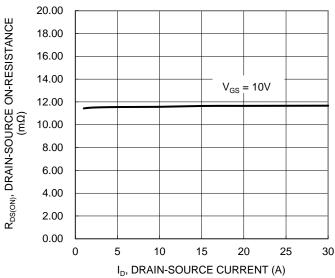


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

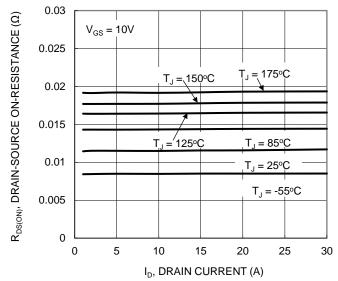
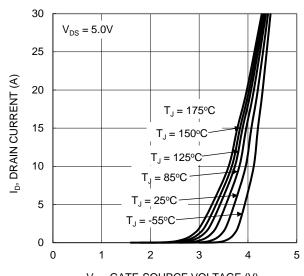


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

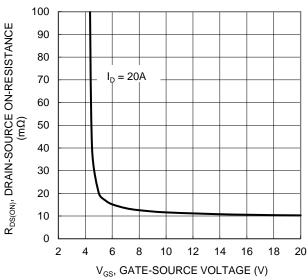


Figure 4. Typical Transfer Characteristic

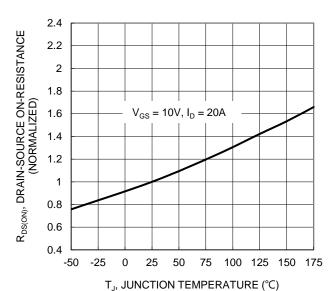
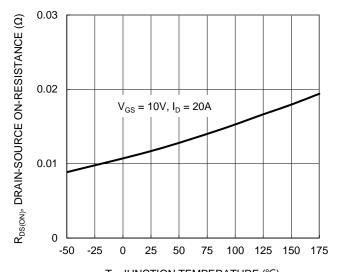


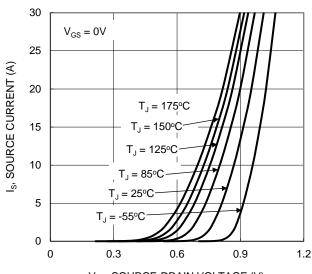
Figure 6. On-Resistance Variation with Temperature



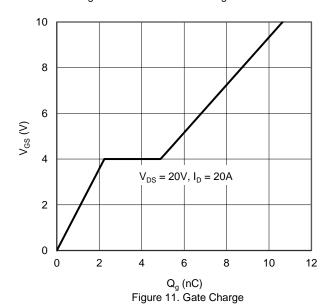




 $\rm T_{J}, JUNCTION \, TEMPERATURE \, (^{\circ}C)$ Figure 7. On-Resistance Variation with Temperature

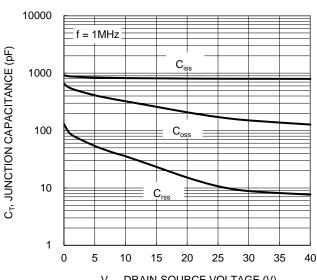


V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

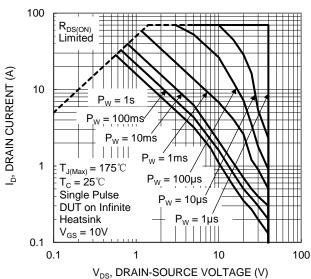


3.5 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 3 $I_D = 1mA$ 2.5 2 $I_{D} = 250 \mu A$ 1.5 1 0.5 0 -50 -25 0 25 50 75 100 125 150 175

 $T_{\rm J},$ JUNCTION TEMPERATURE (°C) Figure 8. Gate Threshold Variation vs. Temperature



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 10. Typical Junction Capacitance



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



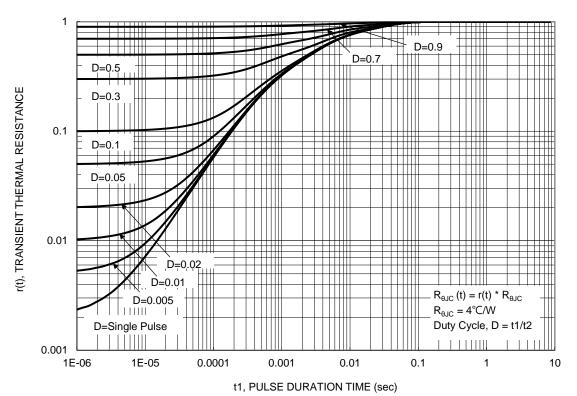


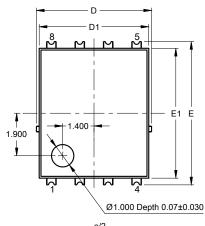
Figure 13. Transient Thermal Resistance

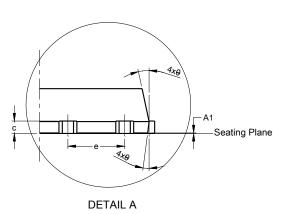


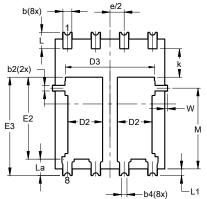
Package Outline Dimensions

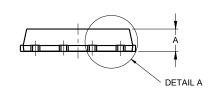
Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)







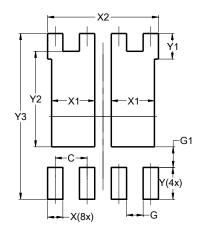


PowerDI5060-8/SWP						
(Type UXD)						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF	=			
С	0.230	0.330	0.277			
D	5	.15 BS0	2			
D1	4.70	5.10	4.90			
D2	1.46	1.66	1.55			
D3	3.78	4.18	3.98			
Е	6	.40 BS0				
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1	.27BSC				
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
M	3.205	4.005	3.605			
W	0.025	0.225	0.125			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	1.720		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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